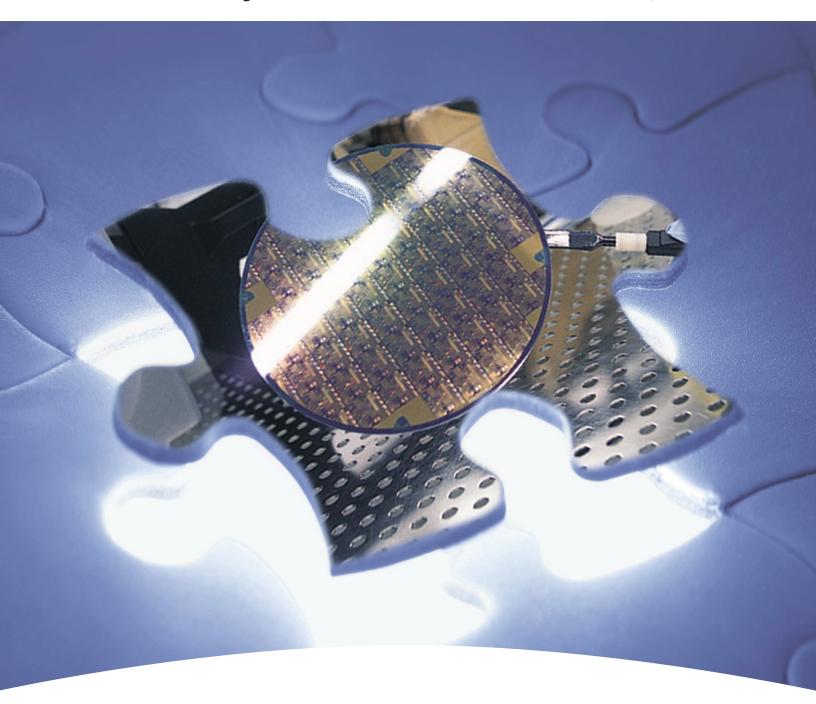
Electronic Polymers

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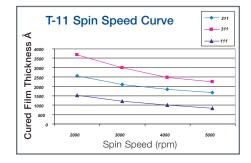
Honeywell ACCUGLASS® T-11 Spin-on Glass

Honeywell ACCUGLASS® T-11 Spin-on Glass

ILD AND IMD PLANARIZATION AND GAP FILL

BENEFITS

- Industry proven performance and broad acceptance
- T-11 fills gaps as small as 0.3µm
- High thermal stability. Compatible with hot aluminum and tungsten plug processing. Permeability allows for hydrogen annealing of gate oxides
- Thickness variation within a wafer of less than 1%. Wafer to wafer variation of less than 2%
- Lower dielectric constant compared to silicates and phosphorus silicates
- Crack resistance up to 6000Å
- Good adhesion to top and bottom dielectric layers



OVERVIEW

The ACCUGLASS T-11 ($\kappa=3.8$) Spin-on Glass (SOG) Series is a family of methylsiloxane polymers used for interlevel and overcoat passivation in the manufacture of integrated circuits.

The ACCUGLASS T-11 series is specially formulated to fill narrow (down to 0.3µm), high aspect ratio (up to 4) gaps without voids while planarizing multi-level metal devices.

ACCUGLASS T-11 contains 10 wt% CH₃ (methyl) groups bonded to Si atoms in the Si-O backbone. The specific formulation results in a stable dielectric constant, high crack resistance, excellent gap fill and planarization properties of the cured film.

Thin films of ACCUGLASS T-11 are applied using a commercial coater and cured in a vertical or horizontal furnace to thicknesses up to 3800Å (single coat) and 6000Å (double coat).

FEATURES

Thickness

Product	Thickness Range
111	860Å – 1,500Å
211	1,600Å – 2,600Å
311	2,200Å – 3,800Å

Film Properties Post Cure

Dielectric Constant @ 1 MHz: 3.8

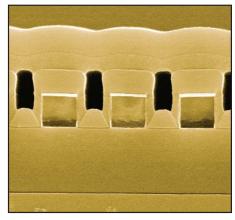
Tensile Stress: 120 MPa

Refractive Index @ 633 nm: 1.39 Coeff. of Thermal Expansion: 5X10⁻⁶K⁻¹

APPLICATIONS

- ILD and PMD Planarization
- Overcoat Passivation
- Gapfill

ACCUGLASS T-11 is suitable for gap fill and planarization of ILD and PMD structures used in multilevel metal IC devices. Typically, partial etchback (PEB) is used for ILD and total etchback (TEB) is used for PMD. ACCUGLASS T-11 can also be used to improve planarization of the final passivation layer.



ACCUGLASS T-11 planarizes and fills gaps to 0.35µm.

Material Properties

111 Shelf Life @ 4°C: 12 months 211 Shelf Life @ 4°C: 8 months 311 Shelf Life @ 4°C: 6 months

Shelf Life Equivalencies @ Room

Temperature: 20°C

111- 1 Day at RT = 2 days in 4°C Storage 211- 1 Day at RT = 5 days in 4°C Storage

311–1 Day at RT = 5 days in 4° C Storage Bottle sizes available:

125ml, 250ml, 500ml, 1L, 2L, 4L



Honeywell Electronic Materials

USA: 1-509-252-2102 China: 86-21-28942481 Germany: 49-5137-999-9199 Japan: 81-3-6730-7092 Korea: 82-2-3483-5076 Singapore: 65-6580-3593 Taiwan: 886-3-6580300 ext.312

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